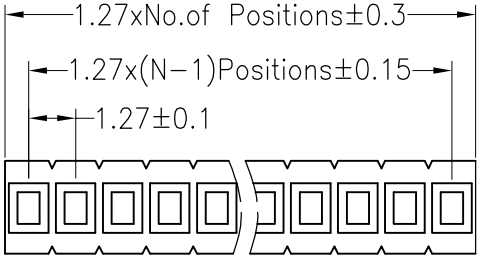
HSF RoHS

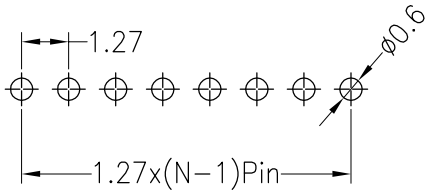
FILE NO :E362810

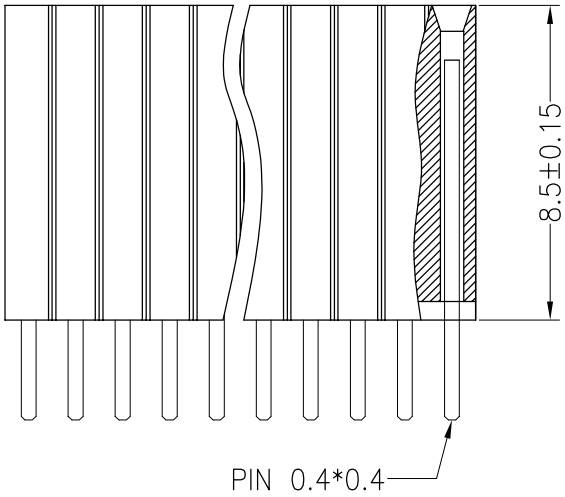
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

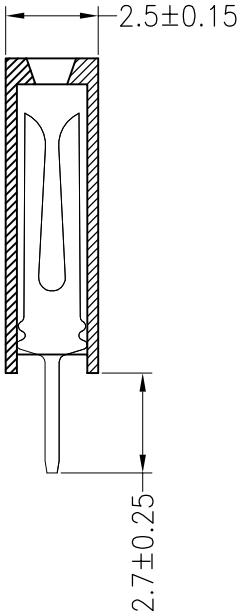
Contact Material:Brass
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

2485 01 XX X N XX S Y X 01

- XX: No.of Pins Per Row 1*50
- X: Insulator Material Option
  - A=BK−PBT
  - B=BK−PA66
  - C=BK−PA6T
  - D=BK−PA46
  - E=BK−PA9T
  - F=BK−LCP
- XX: Contact Plating
  - G0:Gold Flash
  - G1:3U" Gold
  - G2:5U" Gold
  - G3:10U" Gold
  - G4:15U" Gold
  - G5:30U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X: Packing
  - 0=PE Bag
  - T=Tube
  - P=Tube+Cap
  - R=Reel+Cap
  - M=Reel+Mylar

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.18	NEW DRAWING	

OPERATION				
DRAW	YiYuSheng	12.04.18	X.X	±0.30
CHECK			X.XX	±0.20
			X.XXX	±0.10
APPROVE			Angle	±3°
			DIM	TOL

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

BESTCONN(WUHAN) TECHNOLOGY CO.,LTD
https://bscconnector.com/

PART NO.	248501XXXNXXSYX01
TITLE:	1.27PF 1xNPin H8.5 180°